

## PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Chang-Ming Lee</td><td>03/24/2010</td></tr><tr><td>Wen-Fang Liu</td><td>03/24/2010</td></tr><tr><td>Shih-Jung Huang</td><td>03/24/2010</td></tr><tr><td>Ling-Kai Su</td><td>03/24/2010</td></tr></tbody></table>		Name	Execution Date	Chang-Ming Lee	03/24/2010	Wen-Fang Liu	03/24/2010	Shih-Jung Huang	03/24/2010	Ling-Kai Su	03/24/2010
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Ling-Kai Su	03/24/2010										
RECEIVING PARTY DATA											
Name:	Unimicron Technology Corp.										
Street Address:	NO.38, HSING PONG RD., KWEI-SAN INDUSTRIAL ZONE										
City:	TAOYUAN										
State/Country:	TAIWAN										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12837462</td></tr></tbody></table>		Property Type	Number	Application Number:	12837462						
Property Type	Number										
Application Number:	12837462										
CORRESPONDENCE DATA											
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Total Attachments: 2 source=890816#page1.tif source=890816#page2.tif											

CH \$40.00 12837462

PATENT

501234329

REEL: 024694 FRAME: 0215

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

**ASSIGNOR(S) (Inventors):**

Name: Chang-Ming Lee Nationality: TW

Name: Wen-Fang Liu Nationality: TW

Name: Shih-Jung Huang Nationality: TW

Name: Ling-Kai Su Nationality: TW

Hereby sells, assigns and transfers to

**ASSIGNEE(S):**

Name: Unimicron Technology Corp.

Address: NO.38, HSING PONG RD., KWEI-SAN INDUSTRIAL ZONE, TAOYUAN 333,  
Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"METHOD FOR FABRICATING AN INTERPOSER"

Which is found in :

- (a) + U.S. patent application executed on even date
- (b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_
- (c) \_\_\_\_\_ U.S. application serial no. \_\_\_\_\_
- (d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this \_\_\_\_\_ (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Chang-Ming Lee

Wen-Fang Liu

Shih-Jung Huang

Ling-Kai Su

Signature of INVENTOR

Chang Ming Lee 2010.3.24  
Wen-fang Liu Mar. 26, 2010  
Shih-Jung Huang 2010.3.24  
Ling-Kai Su 99.3.24 MAR 24 2010